UNISONIC TECHNOLOGIES CO., LTD

6N60-CB **Preliminary** Power MOSFET

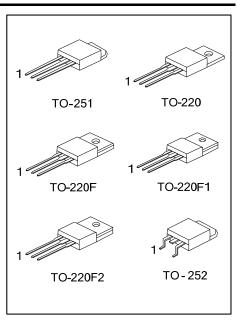
6.0A, 600V **N-CHANNEL POWER MOSFET**

DESCRIPTION

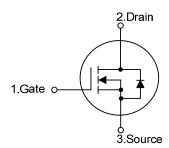
The UTC 6N60-CB is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)}$ < 1.44 Ω @ V_{GS} = 10V, I_{D} = 3.0A
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness



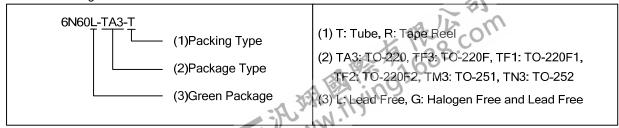
SYMBOL



ORDERING INFORMATION

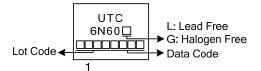
Ordering Number		Doolsons	Pin Assignment			Decking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
6N60L-TA3-T	6N60G-TA3-T	6N60G-TA3-T TO-220 G		D	S	Tube	
6N60L-TF1-T	6N60G-TF1-T	TO-220F1	G	D	S	Tube	
6N60L-TF2-T	6N60G-TF2-T	TO-220F2	G	D	S	Tube	
6N60L-TF3-T	6N60G-TF3-T	TO-220F	G	D	S	Tube	
6N60L-TM3-T	6N60G-TM3-T	TO-251	G	D	S	Tube	
6N60L-TN3-R	6N60G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



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MARKING





ABSOLUTE MAXIMUM RATING (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL RATINGS		UNIT
Drain-Source Voltage		V_{DSS}	150	V
Gate-Source Voltage		V_{GSS}	±20	V
Danier Occurrent	Continuous	I_D	6	Α
Drain Current	Pulsed (Note 2)	I _{DM}	24	Α
Avalanche Current (Note 2)	I _{AR}	3.7	Α	
Avalanche Energy (Note 3)	Single Pulsed (Note 3)	E _{AS}	68	mJ
Peak Diode Recovery dv/dt (Not	eak Diode Recovery dv/dt (Note 4)		3	V/ns
	TO-220		125	W
Davier Dissipation	TO-220F/TO-220F1		40	W
Power Dissipation	TO-220F2	P _D	42	W
	TO-251/TO-252		55	W
Junction Temperature		TJ	+150	°C
Storage Temperature Range		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH, I_{AS} = 3.7A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 4. $I_{SD} \le 6.0$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le V_{(BR)DSS}$, $T_J = 25$ °C

THERMAL DATA

PARAMETER	PACKAGE	SYMBOL	RATINGS	UNIT	
Junction to Ambient	TO-220/TO-220F		62.5	°C/W	
	TO-220F1/TO-220F2	θ _{JA}	02.5	C/VV	
	TO-251/TO-252		110	°C/W	
Junction to Case	TO-220		1.0	°C/W	
	TO-220F/TO-220F1	0	3.2	°C/W	
	TO-220F2	θ_{JC}	2.97	°C/W	
	TO-251/TO-252		2.27	°C/W	



ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

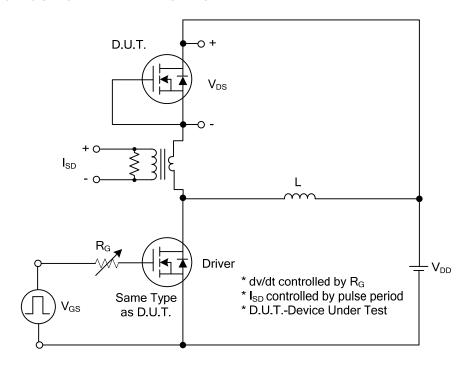
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS} =0V, I_{D} =250 μ A	600			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V, V _{GS} =0V			1	μΑ
Gate- Source Leakage Current	Forward		$V_{G=}30V$, $V_{DS}=0V$			100	nA
	Reverse	I _{GSS}	V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V_{GS} =10V, I_{D} =3.0A			1.44	Ω
DYNAMIC CHARACTERISTICS				-	=.		
Input Capacitance	nput Capacitance				900		pF
Output Capacitance		Coss	V_{GS} =0V, V_{DS} =25V, f=1.0 MHz		85		pF
Reverse Transfer Capacitance		C_{RSS}			4		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge (Note 1)		Q_{G}	V _{DS} =50V, V _{GS} =10V, I _D =1.3A		59		nC
Gate to Source Charge		Q_{GS}	I _G =100μA (Note 1, 2)		5		nC
Gate to Drain Charge		Q_{GD}	IG-100μΑ (Note 1, 2)		4		nC
Turn-on Delay Time (Note 1)		$t_{D(ON)}$	V_{DD} =30V, V_{GS} =10V, I_{D} =0.5A, R_{G} =25 Ω (Note 1, 2)		46		ns
Rise Time		t_R			30		ns
Turn-off Delay Time		$t_{D(OFF)}$			164		ns
Fall-Time		t _F			26		ns
SOURCE- DRAIN DIODE RATING	GS AND CH	ARACTERIS	TICS				
Maximum Body-Diode Continuous Current		I_S				6.0	Α
Maximum Body-Diode Pulsed Current		I _{SM}				24.8	Α
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =6A, V _{GS} =0V			1.4	V
Reverse Recovery Time (Note 1)		t _{rr}	 - _{IS} =6A, V _{GS} =0V, dI _F /dt=100A/μs		360		ns
Reverse Recovery Charge		Q_{rr}	IS-OA, VGS-OV, dif/di-100A/μS		1.85		μC

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

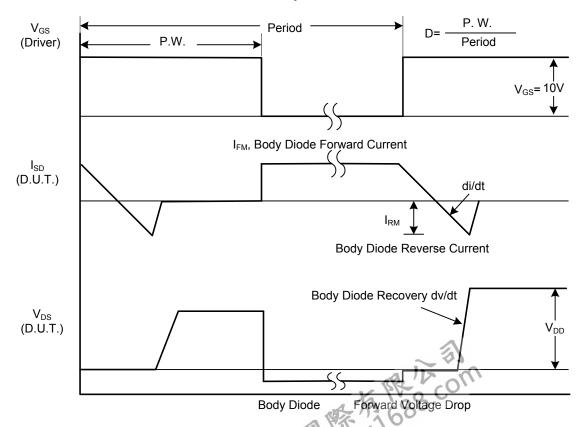


^{2.} Essentially independent of operating temperature.

TEST CIRCUITS AND WAVEFORMS

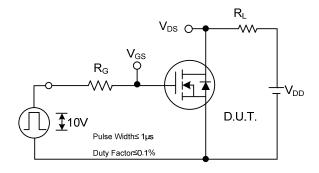


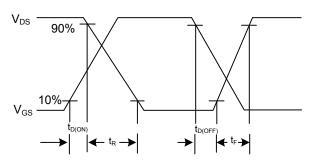
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

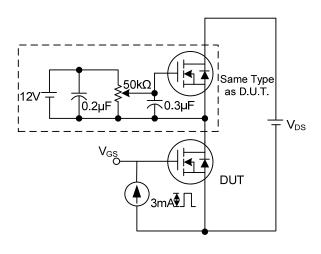
TEST CIRCUITS AND WAVEFORMS (Cont.)

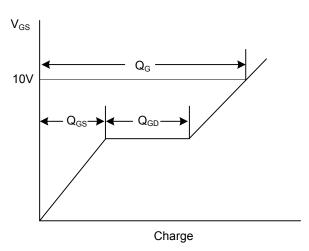




Switching Test Circuit

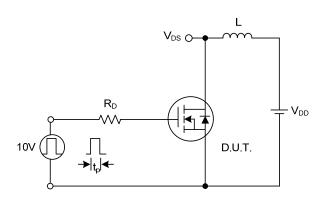
Switching Waveforms

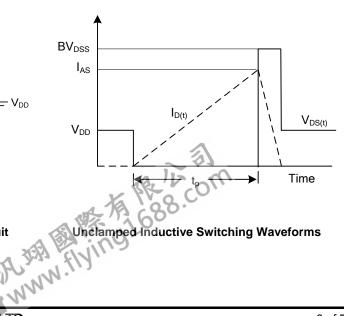




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

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